CHEMISTRY THAT MATTERS™



ULTEM[™] AND EXTEM[™] RESINS IN PHOTONICS

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SABIC A GLOBAL LEADER IN CHEMICALS

Ranked among the world's largest petrochemicals manufacturers, SABIC is a public company based in Riyadh, Saudi Arabia. For over 40 years, our ambition to define the future of petrochemicals and thermoplastics has yielded solutions for the challenges of today and helped our customers achieve their ambitions for a better tomorrow.

We believe the answer to some of the world's biggest challenges lies in the natural human instinct to collaborate. We're making sure we understand the megatrends that will impact on our lives in the years to come.

We are making a meaningful impact in the world and sustainability is a vital part of our core business strategy.

From enabling energy efficient high-bandwidth datacenters, to making cars and planes more fuel-efficient and helping conserve the world's water supply, we find solutions to the challenges of today to help our customers achieve their ambitions and build a better tomorrow.

Together we're making Chemistry that Matters™.

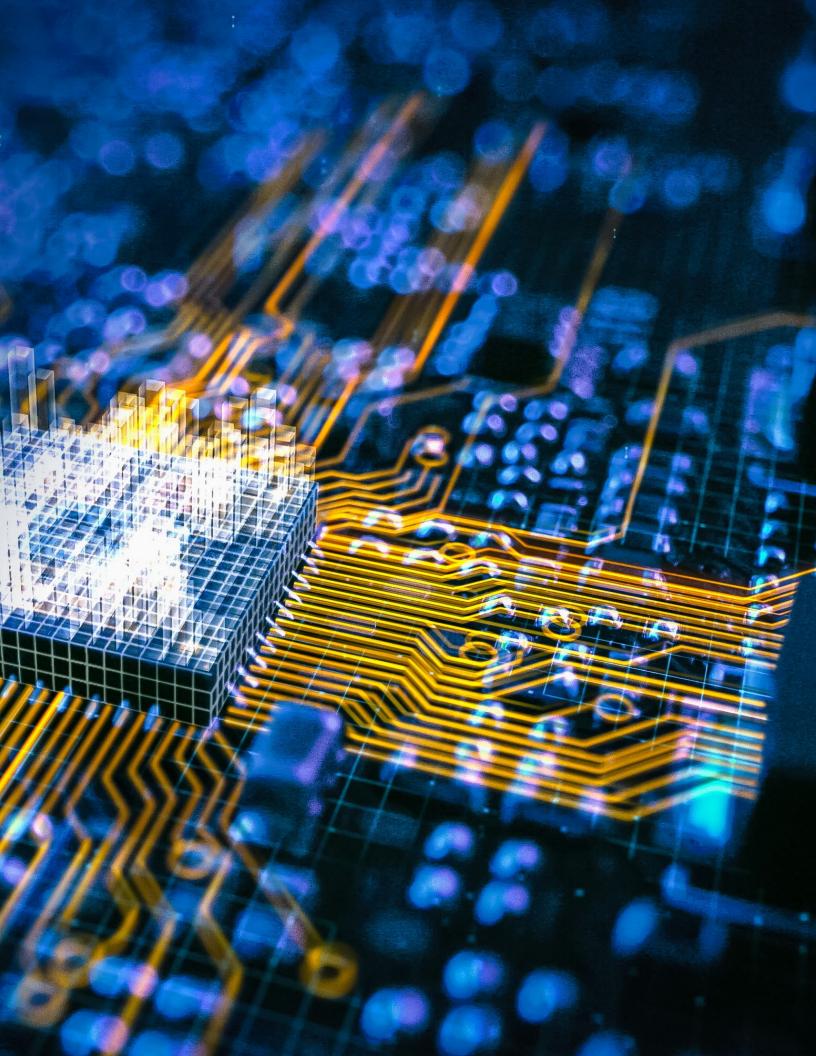


"Our ULTEM[™] resins have been used for decades to produce near infrared transparent lenses in fiber optic connectors, pluggable optical transceivers, and sensors. Co-packaged optics are a nextgeneration technology that can help increase data center bandwidth and reduce power consumption and costs by bringing the optical connection much closer to the main switching ASIC.

Producing miniaturized lens arrays with complex shapes for co-packaged optics calls for new materials that can overcome the design, manufacturing scalability and system cost drawbacks of glass or direct silicon integration. SABIC's new EXTEM[™] RH resin addresses these needs as it allows optical engineers the design freedom of injection molding but also the assembly efficiency enabled by having multiple solder reflow capability. We see this material helping enable a more rapid transition to on-board and co-packaged optics".

Luc Govaerts

Technology Director SABIC's Specialties Business



POTENTIAL BENEFITS OF SABIC'S ADVANCED OPTICAL THERMOPLASTIC RESINS

SABIC has several decades of history in supplying thermoplastic polymers in the opto-electronics industry. Optical elements in data communication and mobile applications play a critical role for seamless connectivity of electronic devices and back-end infrastructures.

Design Freedom & Miniaturization

Complex optical components that can be micromolded with thermoplastics are potentially difficult to produce using alternative material solutions like glass or thermoset resins For example: co-packaged optical interconnects.

Integration & Simplification

Thermoplastics are well-suited for the integration of mechanical and optical features to simplify design and assembly for potential cost improvement. For example alignment fixtures.

Optical interconnect lens designed and produced by Nalux Co., Ltd.

Mass Production with High Precision

Injection molding of thermoplastics can enable high precision manufacturing of complex parts at large build numbers. For example: micro-lens arrays

Assembly of mixed materials

Integration of multiple components can be accomplished with two-shot injection molding:

- Optical and light blocking
- Optical and rigid alignment/mounting For example, over-molding with other thermoplastics.



Source: Soprod SA

OPTICAL DESIGNS THAT CAN BE PRODUCED AT SCALE

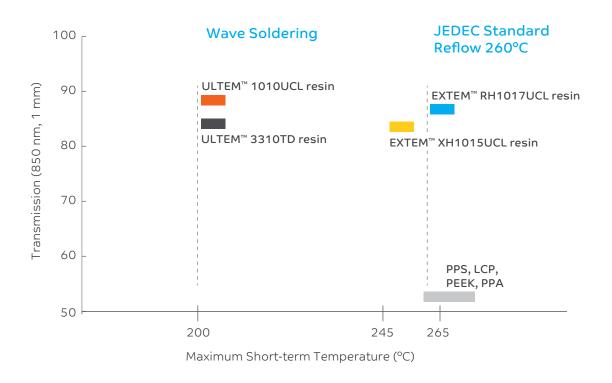






OUR PORTFOLIO MEETS VARIOUS REQUIREMENTS OF THE OPTICAL INDUSTRY

SABIC offers a broad portfolio of ULTEM[™] and EXTEM[™] resins to address material requirements for the photonics industry, including the ability to withstand the high heat of typical opto-electronic solder processes.



ULTEM resin (polyetherimide)

ULTEM resins are near infrared transparent, amorphous thermoplastic resins with a low thermal expansion coefficient (CTE). They are well suited for use in multi mode optical lens assemblies in photonics.

ULTEM 3310TD resin offers ~ 30% reduction in CTE while retaining optical transmission and is wellsuited where extra tight alignment tolerances are required, like lenses for single mode optics in data centers.

EXTEM resin (polyimide)

EXTEM resins offer superior heat resistance with near infrared transparency.

They can maintain stiffness and dimensional stability for mounting of parts and modules in a PCB assembly with SAC/SMT reflow soldering (245 - 260°C) process according JEDEC J-STD-020A.

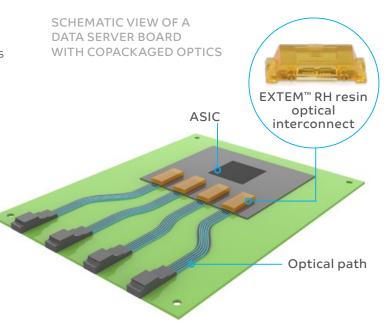
For beam steering with metallized surfaces, EXTEM resins offer smoother surface and higher reflectivity compared to other, filled resins.

EXTEM[™] RESIN IN ON-BOARD OPTICAL INTERCONNECTS

Trends in improved user experience, functionality and connectivity are driving both higher bandwidth and speed. Is the industry moving from pluggable to co-packaged solutions? Whichever path you follow, we may have a well-suited material option.



In order to demonstrate the strong value proposition of our EXTEM RH1017UCL resin for possible use in co-packaged optical components requiring reflow soldering at 260°C during assembly, SABIC, together with industry leading partners designed and produced an on-board interconnect with several lens arrays.

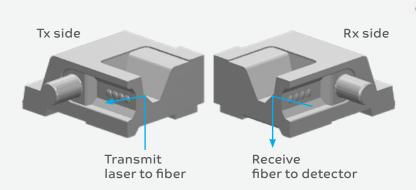


CASE STUDY 1 - EXTEM[™] RESIN

IMPACT OF REFLOW SOLDERING & HYDRO AGING

Key characteristics of the EXTEM RH1017UCL resin-based optical interconnect that SABIC tested for real life assembly and exposure to moisture:

- \bullet 4 Rx and 4 Tx lens array on bottom and front with 250 μm spacing
- Total internal reflection to front and bottom lenses
- Front MPO fiber connection, using Multi Mode 850 nm light
- Dimensions: 4.3 x 8.9 x 2.1 mm (W x L x H)



The connector was micro-molded and then exposed to several treatments:

1) Reflow Soldering according JEDEC 260°C (3 x)

2) Hydro aging according to Telcordia

The connector was assembled to a PCB and aligned with laser and detector to measure signal loss of all 8 channels in dB before and after these exposures.



Key test results using 5 parts are shown in the graph above.

- After 3 times reflow, the optical interconnects show no blistering while maximum signal loss was only 0.4dB.
- Hydro aging for 1000 hours did not result in haziness or any other visual defect, and signal loss did not exceed 1 dB.

These results are well within OEM specifications that SABIC used as a reference.

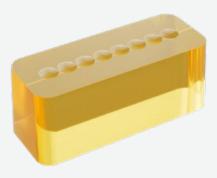
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CASE STUDY 2 - EXTEM[™] RESIN

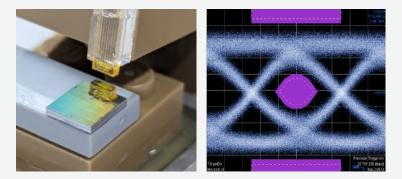
SURFACE COUPLING BY CO-PACKAGING EXTEM RESIN

Key characteristics of the EXTEM RH1017UCL resin deployment in a free-space, expanded beam, pluggable fiber-to-PIC (photonic integrated circuit) connector assembly.

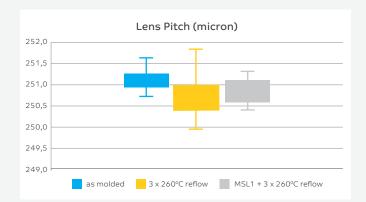
- 2 Micro Lens Arrays (MLA) to expand beam of single mode 1310 nm
- Shape and features of EXTEM resin MLA retained after reflow soldering
- EXTEM resin is capable for prototyping and fabrication of critical optical elements of photonic packages for increasing market demand of copackaged optics



Lens pitch: 250 µm 5nm Ra surface roughness Radius of curvature: 400 µm

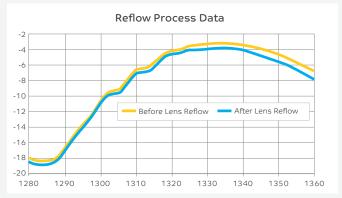


The MLA was micro-molded and then an anti-reflective coating was applied on top of the MLA, after which the MLA was aligned to both the PIC and fiber array unit with DELO Dualbond® OB6235.



The demonstrator is placed in a simple transmission network, with pluggable SFP28 optical transceiver with up to 2.5dBm optical power. Signal integrity as measured by an oscilloscope shows a non degenerated open eye diagram, fully compliant with the mask standard.

Box plots of lens-lens distances of three different MLAs, after micro molding, after reflow and after MSL1 hydroaging/ reflow, confirming significant dimensional stability and suitability for co-packaged optics.



Effect of reflow process @ 260°C on the optical signal quality of the EXTEM MLA resin. The difference in the spectra is negligible, indicating solid dimensional stability of the MLA after reflow.

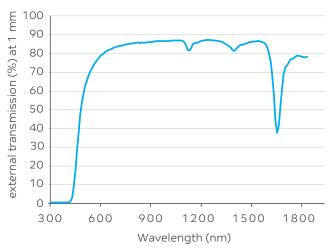


EXTEM[™] RH1017UCL RESIN IN OPTICAL SENSING

Today, sensors are widely used in a growing number of applications. Some of these are proximity sensors, 3D sensing cameras and biometric monitoring devices. These application spaces keep growing at a high rate and upgraded functionalities require higher lens complexity.

EXTEM RH1017UCL resin's high near IR light transmission may be used in optical sensor applications in various wavelengths. Time-of-Flight (ToF) lenses for collimating both emitting and receiving light can be produced with EXTEM RH1017UCL resin. The use of anti-reflective coatings enables an even higher transmission if required for a specific application.

EXTEM RH1017UCL resin offers key advantages versus glass such as design freedom, part integration and is easy scalable, with cost-efficient production by multi cavity micro molding. Often JEDEC reflow soldering at 260°C is required during the sensor assembly process and EXTEM RH1017UCL offers this capability.



EXTERNAL TRANSMISSION OF EXTEM RH10107UCL RESIN

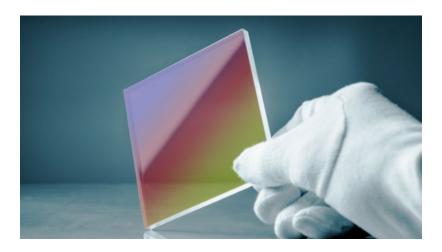
ANTI-REFLECTIVE COATINGS TO IMPROVE EXTEM[™] RESIN OPTICAL TRANSMISSION

Anti-reflection coatings (ARC) reduce first surface reflection losses, improve contrast and boost the transmission through the optical surface. By applying these coatings on EXTEM[™] resin, more light is transmitted through the lenses, enabling a higher sensitivity for optical sensors or lower signal losses for fiber optical connectors.

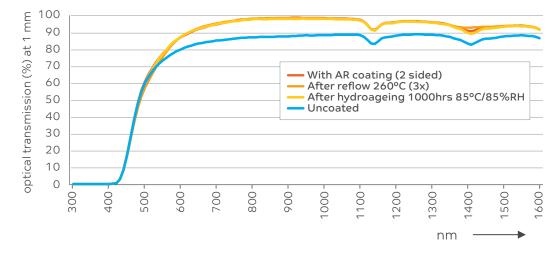
SABIC has worked with multiple manufacturers to test anti-reflective coatings for EXTEM resin. Plaques of 1 mm thickness successfully passed solder reflow conditions* and 2000 hours of hydro-aging**. The anti reflective layer did not show any cracking.

* according industry standard JEDEC J-STD-020A (3 x 260 °C)





EXTEM[™] RH1017UCL RESIN OPTICAL TRANSMISSION IMPROVEMENT USING ANTI REFLECTIVE COATING (ARC)



ADHESIVES FOR INDUSTRIAL ASSEMBLY OF EXTEM[™] RESIN

In the assembly of opto-electronic packages, adhesives play a key role to bond lenses and substrates. Using mainstream assembly techniques for mass production of optical modules, SABIC tested a wide range of adhesives in collaboration with DELO. This includes transparent, low-outgassing and tension-equalizing adhesives to compensate for thermal expansion differences between EXTEM resin and substrates.

All the tested adhesives are light fixable and suitable for heat curing (130°C) and perform well with die shear higher than 20N.

The test specimen are EXTEM resin lenses (4*2*0.6mm) with an adhesive area of 8mm². Average bond line thickness is maintained at 10 to 100 µm and after curing the assemblies are exposed to solder reflow conditions* and 1000 hours of hydro-aging**.

ADHESIVES SUITABLE FOR EXTEM RH SERIES BASED OPTICAL COMPONENTS

DELO INDUSTRIAL Adhesives	Substrate	Optics	Curing method
DELO DUALBOND® OB786	Moderate CTE (i.e. FR4)	Translucent	UV and/or heat
DELO DUALBOND® OB749	Moderate CTE (i.e. FR4)	Translucent	UV and/or heat
DELO DUALBOND® OB6235	Low CTE (i.e. ceramics, Si)	Transparent	UV and/or heat
DELO DUALBOND® LT2208	Low CTE (i.e. ceramics, Si)	Opaque	Heat (UV fixable)
DELO DUALBOND® AD761	Low CTE (i.e. ceramics, Si)	Transparent	UV and/or heat

* according industry standard JEDEC J-STD-020A (3 x 260 °C)

** 85 °C and 85 % RH

SABIC CAN OFFER SUPPORT FROM PART DESIGN TO PRODUCTION

Beyond resins, SABIC also provides design support and conducts performance testing following industry specific standards.

Optical constants for modeling and pre-design

Our optical resins are listed in the Zemax® Optic Studio database.

- Thermo-optic coefficients
- Internal optical transmission data



1550 nm

150

100



Validate optical replication and dimensional positioning

Mold design for manufacturability

- Part Capability and Fill Design
- Flow and Stress Optimization to reduce Birefringence
- Part Production and Lens Analysis

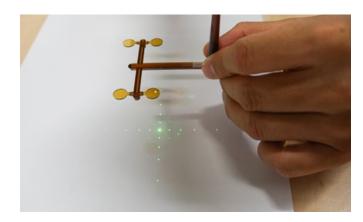
EXAMPLE OF A SHEAR RATE ANALYSIS ON A 4X3 LENS TEST ARRAY (0.3 MM THICKNESS)



Complex light manipulation capabilities

Some examples:

- Injection molding replication techniques for diffractive optics
- Metallization to integrate reflective and transmissive optics





Micro Molding for Research

50

Selected to match customer capabilities:

• Arburg 370A

1,63

0

• Sumitomo SE30EV

Shot weight capabilities:

• 0.05 g to 9.5 g



MATERIAL PROPERTIES

MATERIAL PROPERTIES OF ULTEM[™] AND EXTEM[™] RESIN GRADES

Property*	Standard	Unit	ULTEM™ DT1810EVUCL resin	ULTEM™ 1010UCL resin	EXTEM™ XH1015UCL resin	EXTEM™ RH1017UCL resin
Flexural Modulus	ASTM D790	MPa	3300	3200	3100	3100
Flexural Strength	ASTM D790	MPa	145	165	168	180
HDT, 0.45 MPa	ISO 75	°C	190	207	250	270
Vicat B120	ISO 306	°C	195	212	247	275
Density	ISO 1183	g/cm ³	1.28	1.27	1.31	1.35
CTE (-40 to150°C)	ISO 11359	10 ⁻⁵ /0C	6	5.5	5	5
Transmission at 1mm @ 850nm	ASTM D1003	%	89	88	82	87
Transmission at 1mm @ 1310nm	ASTM D1003	%	89	89	87	88
Refractive index 589 nm (nD)	ISO 489	-	1.655	1.662	1.657	1.663
Refractive index 850 nm	ISO 489	-	1.633	1.639	1.634	1.639
Refractive index 1310 nm	ISO 489	-	1.620	1.626	1.622	1.629
Abbe number	ISO 489	-	21	21	18	18
dn/dT (+23ºC-140ºC) @ 1270nm	ISO 489	10 ⁻⁵ /0C	-11	-10	-10	-10

* The data shown are typical properties

ZEMAX OPTICSTUDIO® PARAMETERS FOR EXTEM RH1017UCL RESIN

Sellmeier Dispersion Equation for Refractive Index			
$n^{2} - 1 = \frac{B_{1}\lambda^{2}}{\lambda^{2} - C_{1}} + \frac{B_{2}\lambda^{2}}{\lambda^{2} - C_{2}} + \frac{B_{3}\lambda^{2}}{\lambda^{2} - C_{3}}$			
Constants of Sellmeier Dispersion [#] Formula			
B1 0.56262			
B2 0.56145			
B3 0.56329			
C1 0.03324			
C2 0.03264			
C3 0.03307			

Temperature Dependence of Refractive Index			
$\Delta n_{abs} = \frac{n^2 - 1}{2n} \bigg[D_0 \Delta T + D_1 \Delta T^2 + D_1 \Delta T^2 \bigg]$	$D_2 \Delta T^3 + \frac{E_0 \Delta T + E_1 \Delta T^2}{\lambda^2 - \lambda_{tk}^2} \bigg]$		
Constants of of Dispersion dn/dT			
Do	-1.78×10 ⁻⁴		
D1	5.42×10 ⁻⁸		
D2	2.89×10 ⁻¹⁰		
Eo	1.13×10 ⁻⁵		
E1	-1.98×10-7		
λ_{tk}	0.00		

These constants are valid for a temperature range from 30 °C to 120 °C and from 0.5 to 1.7 $\mu m.$ Dispersion formula returns a valid refractive index between 0.4 and 1.7 $\mu m.$

SABIC IS A MEMBER OF







SABIC ISCC+ CERTIFIED RENEWABLE ULTEM RESIN SOLUTIONS

A portfolio of bio-based ULTEM[™] resins that delivers a lower carbon footprint while offering the same high performance and processability as incumbent ULTEM materials is available.



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SABIC MATERIAL FINDER Find the right Specialties material for your application



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